

# SANYO Semiconductors DATA SHEET

# 2SK4197FG — General-Purpose Switching Device Applications

#### **Features**

- · Low ON-resistance, low input capacitance, ultrahigh-speed switching.
- · Adoption of high reliability HVP process.
- · Attachment workability is good by Mica-less package.
- · Avalanche resistance guarantee.

#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		600	V
Gate-to-Source Voltage	V <sub>GSS</sub>		±30	V
Drain Current (DC)	I <sub>Dc</sub> *1	Limited only by maximum temperature Tch=150°C	3.5	Α
	IDpack *2	Tc=25°C (SANYO's ideal heat dissipation condition)*3	3.3	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	13	Α
Allowable Power Dissipation	Do		2.0	W
	PD	Tc=25°C (SANYO's ideal heat dissipation condition)*3	28	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *4	EAS		29	mJ
Avalanche Current *5	IAV		3.3	А

Note: \*1 Shows chip capability.

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminium.

Marking: K4197

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<sup>\*2</sup> Package limited.

<sup>\*3</sup> SANYO's condition is radiation from backside.

<sup>\*4</sup> VDD=50V, L=5mH, IAV=3.3A

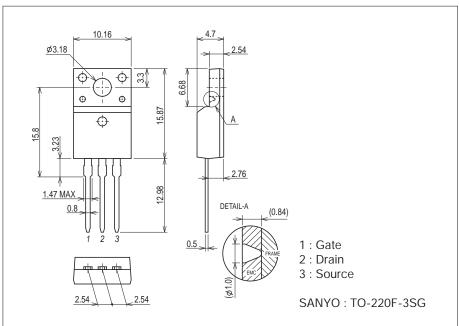
<sup>\*5</sup> L≤5mH, Single pulse

## Electrical Characteristics at Ta=25°C

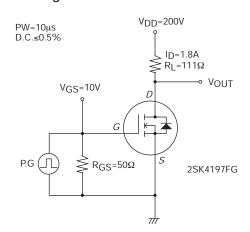
Parameter	Symbol	Conditions	Ratings			Linit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	600			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =480V, V <sub>GS</sub> =0V			100	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±30V, V <sub>DS</sub> =0V			±100	nA
Cutoff Voltage	V <sub>GS</sub> (off)	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	3		5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =1.8A	0.8	1.6		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)	I <sub>D</sub> =1.8A, V <sub>G</sub> S=10V		2.5	3.25	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =30V, f=1MHz		260		pF
Output Capacitance	Coss	V <sub>DS</sub> =30V, f=1MHz		50		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =30V, f=1MHz		9.7		pF
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		12		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit.		20		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		28		ns
Fall Time	t <sub>f</sub>	See specified Test Circuit.		12		ns
Total Gate Charge	Qg	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		11		nC
Gate-to-Source Charge	Qgs	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		2.6		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =200V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.5A		5.8		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =3.5A, V <sub>GS</sub> =0V		0.9	1.2	V

# **Package Dimensions**

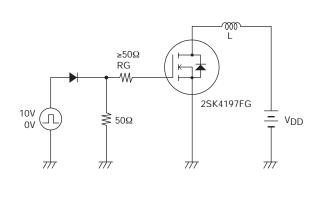
unit : mm (typ) 7529-001



# **Switching Time Test Circuit**



#### **Avalanche Resistance Test Circuit**



#### 2SK4197FG

For this package, a part of inner electrode is exposed. Please refer to the package outline for the detailedstructure.

So when mounting the device, please pay enough attention to the isolation with the heatsink.

According to the device mounting method, sometimes the insulation voltage may be decreased.

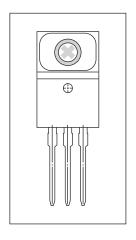
(refer to the below insulation characteristics)

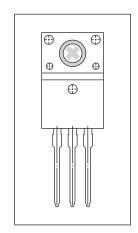
## Insulation / Ta=25°C / RH75%

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Utilit
Lead & resin insulation *	V <sub>ISO</sub> 1	Metal spacer Refer to Fig.1		1600		Vrms
	VISO2	Washer 5.8mm Refer to Fig.2		2100		Vrms
	VISO3	Insulated screw, Insulated washer		3900		Vrms

Fig.2

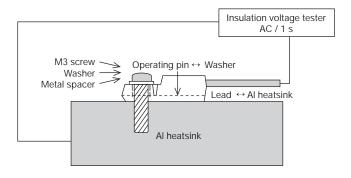
Fig.1





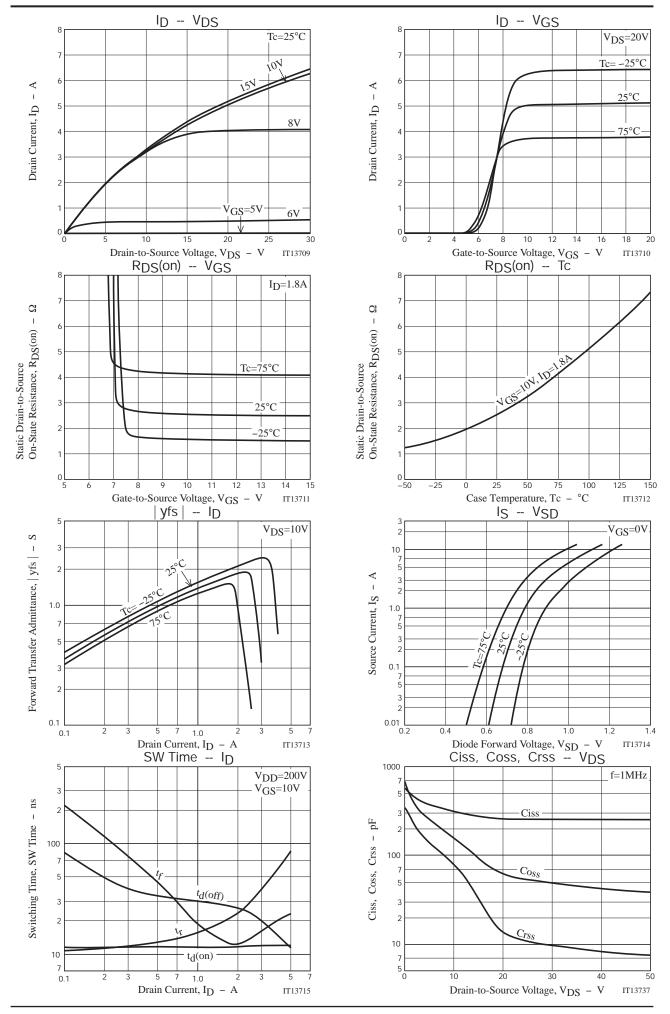
IT14077 IT14078

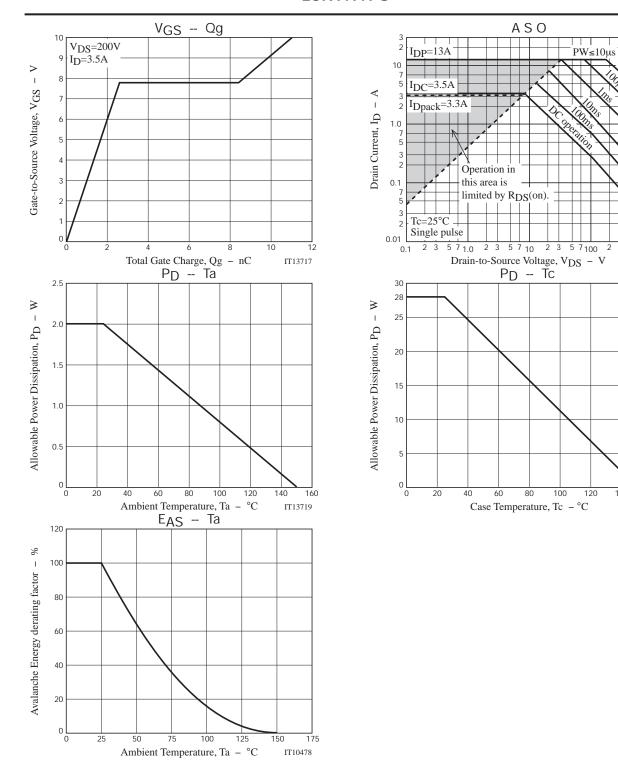
# **Insulation Measuring Diagram**



IT14079

<sup>\*:</sup> AC voltage measurement





IT14236

140

160

IT13720

Note on usage: Since the 2SK4197FG is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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